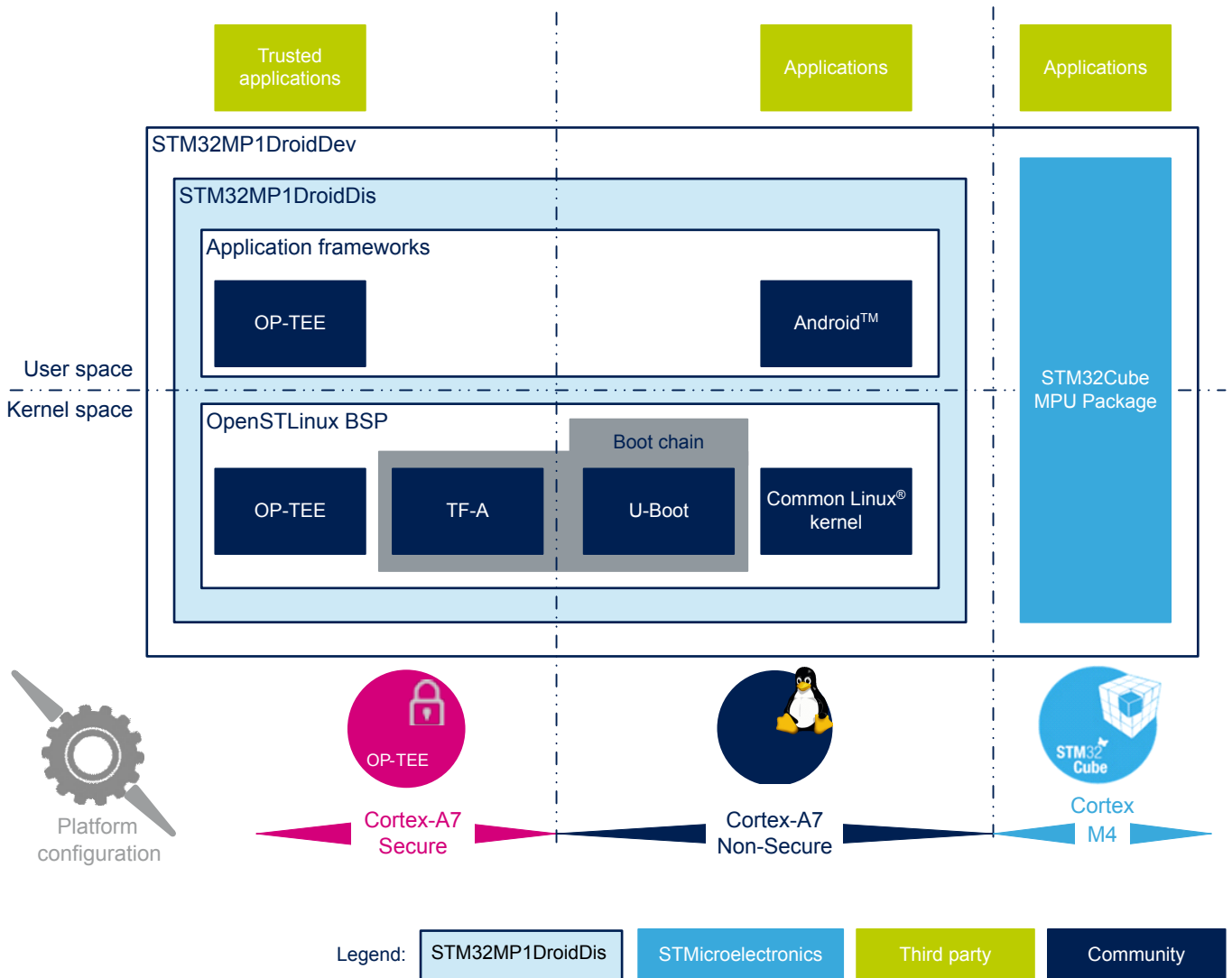


STM32MP1 Series distribution package for Android™



Product status link

[STM32MP1DroidDis](#)

Features

- Android™ application frameworks running in Linux® OS user space
- OpenSTLinux BSP with:
 - Boot chain based on TF-A and U-Boot
 - OP-TEE secure OS running on the Arm® Cortex®-A in secure mode
 - Linux® kernel running on the Arm® Cortex®-A in non-secure mode

Description

The [STM32MP1DroidDis](#) is the STM32 MPU Distribution for Android™ based on the Android™ build framework. It includes the following collection of software components: the Android™ application frameworks, and the OpenSTLinux BSP (OP-TEE secure OS, boot chain and Linux® kernel).

1 General information

The STM32MP1DroidDis Distribution runs on STM32 microprocessors based on Arm® Cortex® cores.

1.1 Ordering information

STM32MP1DroidDis is available for free download from the www.st.com website.

1.2 License

STM32MP1DroidDis is delivered under the *Mix Ultimate Liberty+OSS+3rd-party V1* software license agreement (SLA0048).

Software component license agreements

The software components provided in this package come with different license schemes. Refer to https://wiki.st.com/stm32mpu/wiki/STM32MPU_distribution_for_Android_licenses for details.

Note: **Arm** is a registered trademark of Arm Limited (or its subsidiaries) in the US and/or elsewhere.
Android is a trademark of Google LLC.
All other trademarks are the property of their respective owners.



Revision history

Table 1. Document revision history

Date	Version	Changes
25-Feb-2020	1	Initial release.

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST’s terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2020 STMicroelectronics – All rights reserved